

RF Inductor



BSCH Series



Overview

RF inductors are designed to operate at high frequencies, typically in the MHz to GHz range. Unlike power inductors, RF inductors are optimized for signal processing in radio frequency (RF) circuits. They play a vital role in tuning, filtering and impedance matching in communication and signal transmission systems.

Benefits

1. High frequency performance, for efficient operation at radio frequencies with minimal loss.
2. It can reduce noise and distortion and maintain the integrity of radio frequency signals.
3. Space-saving, suitable for constrained designs in portable devices and IoT applications.
4. Can be customized with specific requirements such as frequency range, impedance and size.

Applications

1. Communication Systems: Mobile phones, Wi-Fi routers, and 5G equipment.
2. Antenna Matching Networks
3. IoT and Smart Devices
4. Medical Devices
5. Consumer Electronics

Product Information

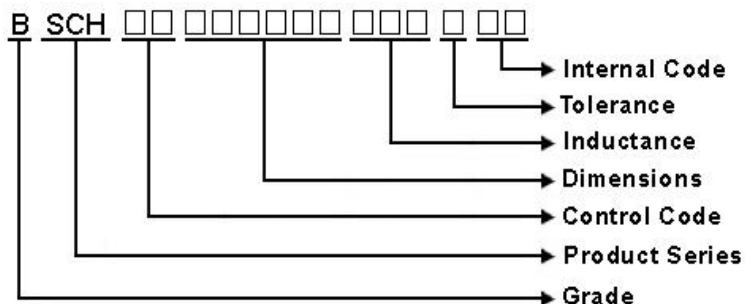
Series	Size Code (JIS/EIA)	Inductance (nH)
BSCH	0603/0201	1 ~ 390
	1005/0402	
	1608/0603	



BSCH00100505 Series Specification

1 Scope: This specification applies to Multilayer ceramic chip inductors

2 Part Numbering:



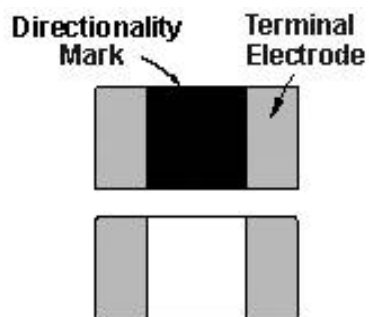
3 Rating:

Operating Temperature: - 5 5 °C ~ 1 2 5 °C(Including self - temperature rise)

Storage Temperature: - 5 5 °C ~ 1 2 5 °C(after PCB)

- 5 °C~ 4 0 °C, Humidity 4 0 %~ 7 0 %(before PCB)

4 Marking:

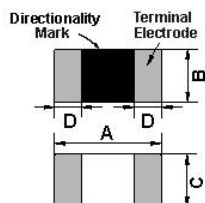


5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

BSCH00100505 Series Specification

6 Configuration and Dimensions:



Dimensions in mm

TYPE	100505
A	1.00±0.10
B	0.50±0.10
C	0.50±0.10
D	0.25±0.10

Net Weight (grms)

Size Code	Net Weight (grms)
BSCH00100505	0.00081

7 Electrical Characteristics:

Part No.	Inductance (nH)	L,Q Test Freq.	Q Min.	SRF (MHz)Typ.	RDC (Ω)Max.	Rated Current (mA)Max.	Tolerance
BSCH001005051N0□SM	1	100 MHz,200 mV	8	10000	0.07	400	S
BSCH001005051N2□SM	1.2	100 MHz,200 mV	8	6000	0.1	400	S
BSCH001005051N5□SM	1.5	100 MHz,200 mV	8	6000	0.1	400	S
BSCH001005051N6□SM	1.6	100 MHz,200 mV	8	6000	0.1	400	S
BSCH001005051N8□SM	1.8	100 MHz,200 mV	8	6000	0.1	400	S
BSCH001005052N0□SM	2	100 MHz,200 mV	8	6000	0.12	400	S
BSCH001005052N2□SM	2.2	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005052N4□SM	2.4	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005052N7□SM	2.7	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005053N0□SM	3	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005053N3□SM	3.3	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005053N6□SM	3.6	100 MHz,200 mV	8	6000	0.15	400	S
BSCH001005053N9□SM	3.9	100 MHz,200 mV	8	6000	0.19	400	S
BSCH001005054N3□SM	4.3	100 MHz,200 mV	8	6000	0.2	400	S
BSCH001005054N7□SM	4.7	100 MHz,200 mV	8	6000	0.2	400	S
BSCH001005055N1□SM	5.1	100 MHz,200 mV	8	6000	0.2	400	S
BSCH001005055N6□SM	5.6	100 MHz,200 mV	8	5300	0.2	400	S
BSCH001005056N2□SM	6.2	100 MHz,200 mV	8	4300	0.25	400	J
BSCH001005056N8□SM	6.8	100 MHz,200 mV	8	4200	0.25	400	J
BSCH001005057N5□SM	7.5	100 MHz,200 mV	8	3900	0.25	400	J
BSCH001005058N2□SM	8.2	100 MHz,200 mV	8	3600	0.3	300	J
BSCH001005059N1□SM	9.1	100 MHz,200 mV	8	3400	0.34	300	J
BSCH0010050510N□SM	10	100 MHz,200 mV	8	3200	0.35	300	J
BSCH0010050512N□SM	12	100 MHz,200 mV	8	2800	0.35	300	J
BSCH0010050515N□SM	15	100 MHz,200 mV	8	2300	0.46	300	J

NOTE: □-tolerance J=±5% / S=±0.3nH

1.Operating temperature range - 5 5 °C ~ 1 2 5 °C(Including self - temperature rise)

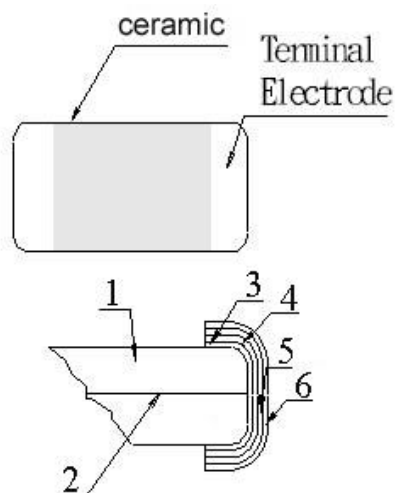
2.IDC:Applied the current to coils, the inductance shall be less than 10% initial value.

3.Residual impedance of short chip : 0.55nH

BSCH00100505 Series Specification

8 BSCH00100505 Series

8.1 Construction:



8.2 Material List:

No	Part	Material
1	Main Substance	Al ₂ O ₃ -B ₂ O ₃ -SiO ₂
2	Silver electrode	Ag
3	Silver electrode	Ag
4	Cu plating	Cu
5	Ni plating	Ni
6	Sn plating	Sn

BSCH00100505 Series Specification

9 Reliability Of Ceramic Multilayer Chip Inductor For High Freq.

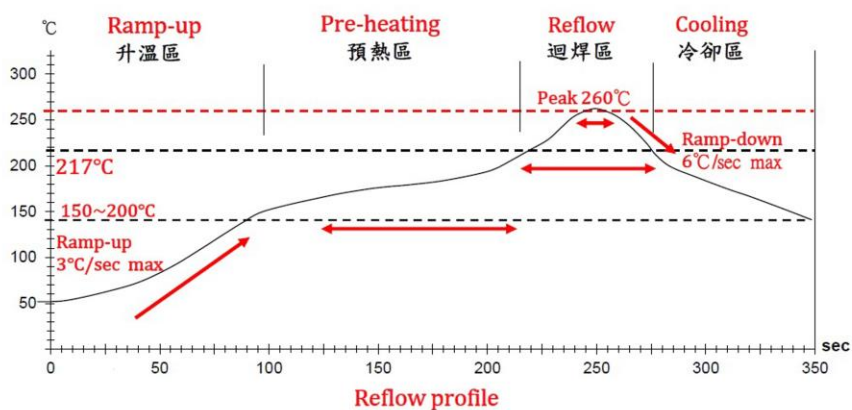
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the Ceramic.	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec *For 100505, substrate dimension is 100x40x0.8mm
1-1-2	Vibration		Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245±5°C (Pb-Free) Immersion Time: 4±1sec

1-2.Environmental Performance

Environmental Performance					
No	Item	Specification	Test Method		
1-2-1	Temperature Cycle	Appearance: No damage Inductance:within±10% of initial value Q change:within±30% of initial value	One cycle:		
			Step	Temperature (°C)	Time (min)
			1	-55±3	30
			2	25±2	3
			3	125±3	30
			4	25±2	3
1-2-2	Humidity Resistance		Total: 100cycles Measured after exposure in the room condition for 24hrs		
			Temperature: 40±2℃ Relative Humidity: 90 ~ 95% Time: 1000hrs Measured after exposure in the room condition for 24hrs		
			Temperature: 125±3℃ Relative Humidity: 0% Applied Current: Rated Current / Time: 1000hrs Measured after exposure in the room condition for 24hrs		
			Temperature: -55±3℃ Relative Humidity: 0% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		
1-2-3	High Temperature Resistance				
1-2-4	Low Temperature Resistance				

BSCH00100505 Series Specification



Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

NOTE :

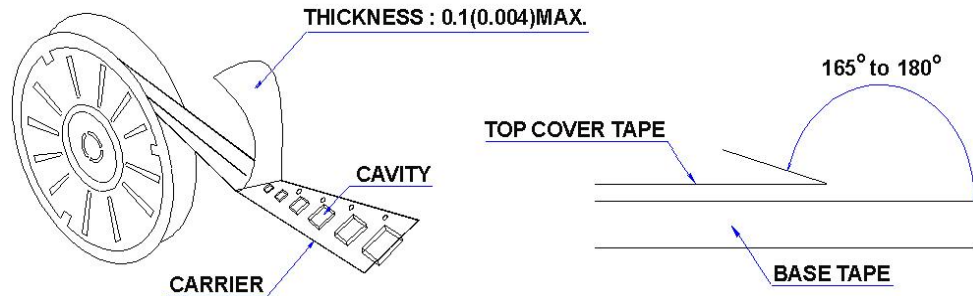
1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow
3. Products can only be soldered with reflow

BSCH00100505 Series Specification

11 Packaging:

11.1 Packaging -Cover Tape

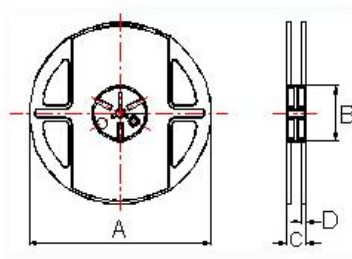
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	PCS/REEL
100505	10000

11.3 Reel Dimensions



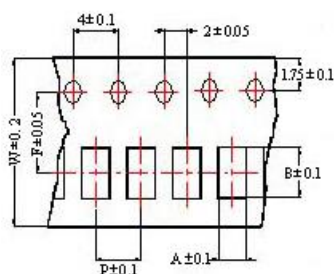
Dimensions in mm

TYPE	A	B	C	D
100505	178	60	12	1.5

BSCH00100505 Series Specification

11 Packaging:

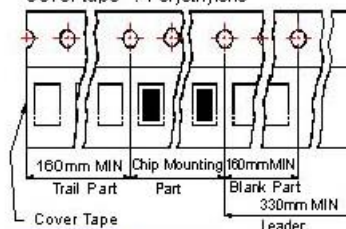
11.4 Tape Dimensions in mm



Tape Material

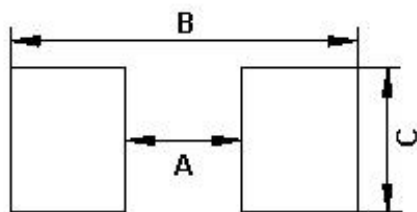
Carrier tape : Paper

Cover tape : Polyethylene



TYPE	A	B	T	W	P	F
100505	0.62	1.12	0.60	8	2	3.5

12 Recommended Land Pattern:



Dimensions in mm

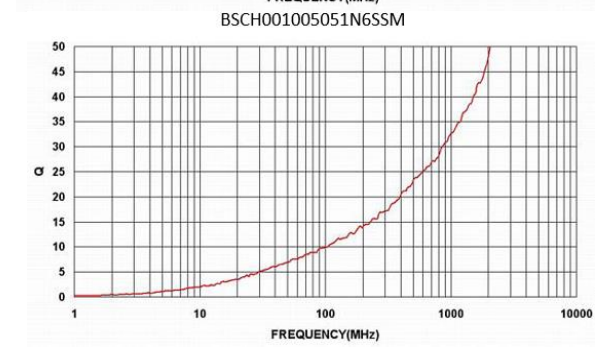
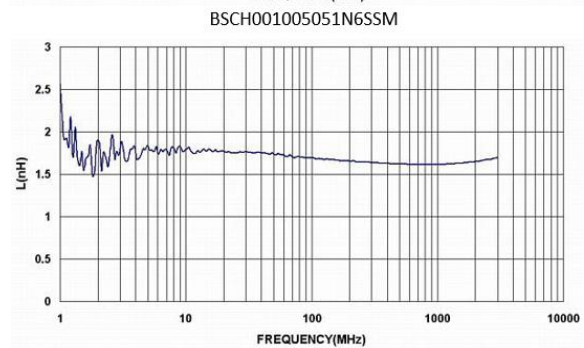
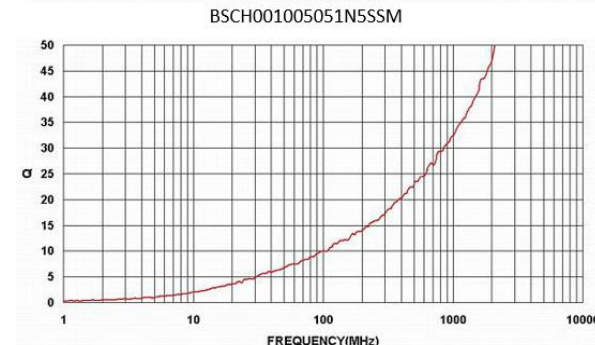
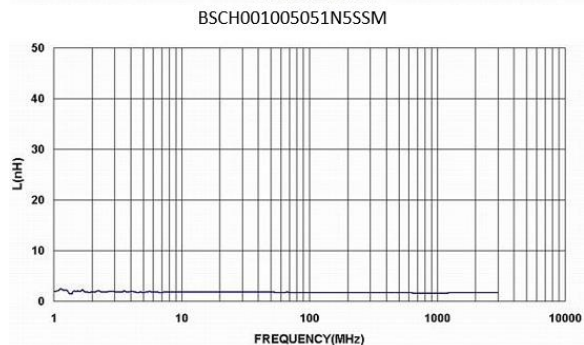
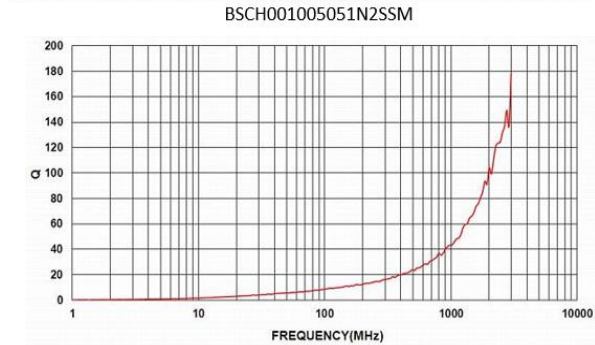
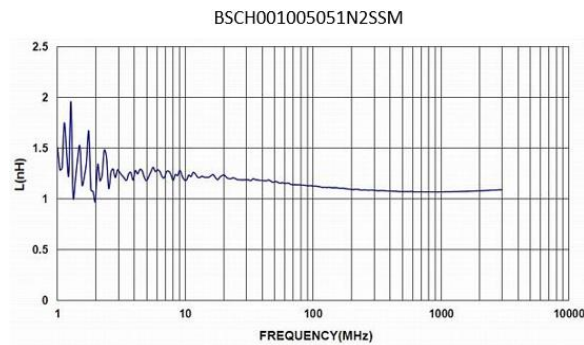
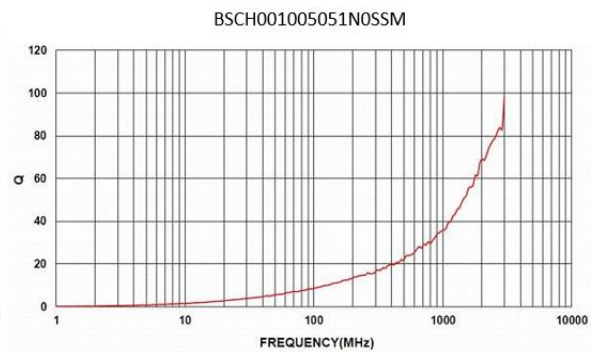
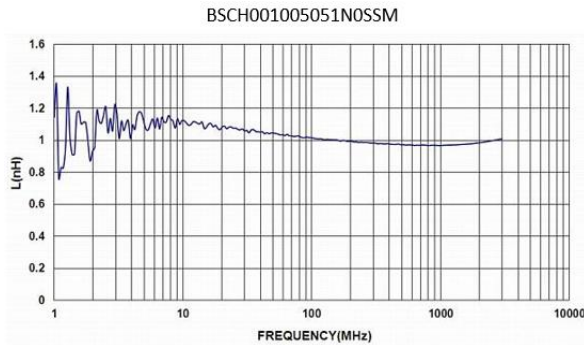
TYPE	A	B	C
100505	0.4	1.2 ~ 1.4	0.5

13 Note:

1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
5. The moisture sensitivity level (MSL) of products is classified as level 1.

BSCH00100505 Series Specification

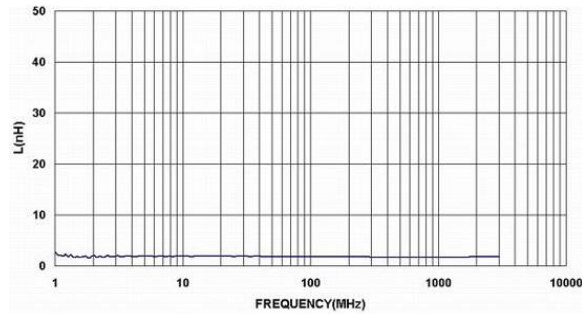
14 Graph:



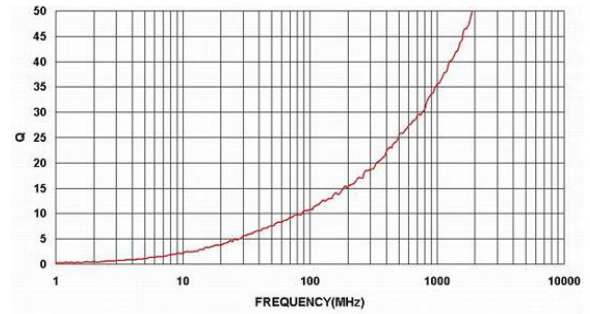
BSCH00100505 Series Specification

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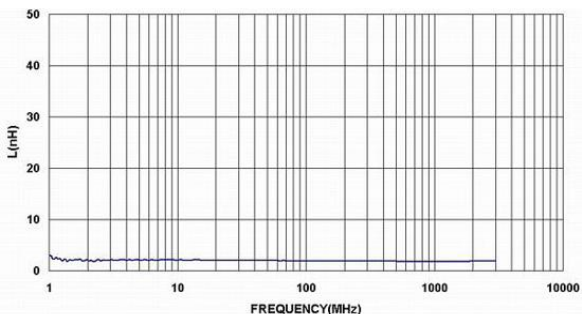
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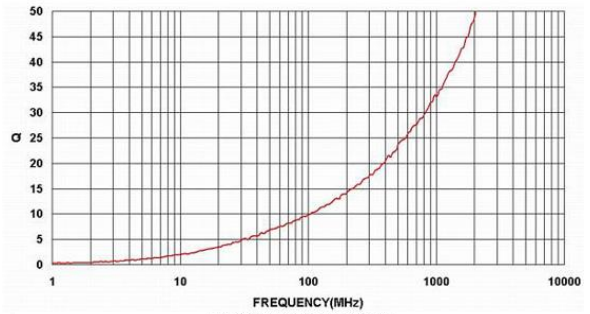
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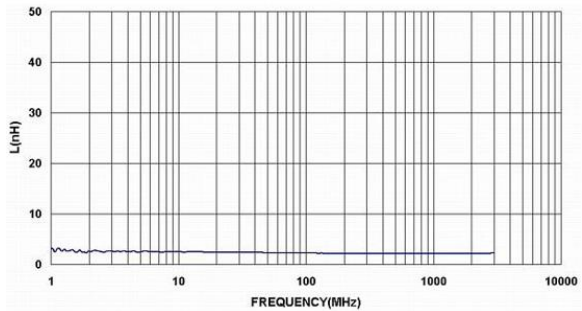
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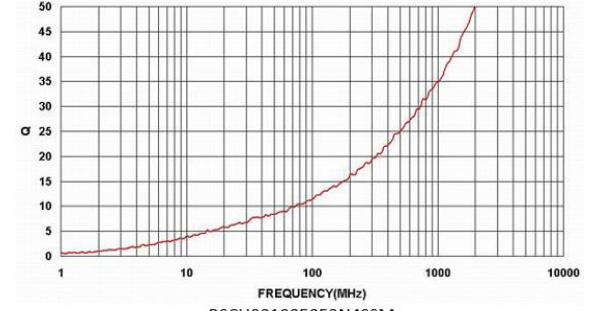
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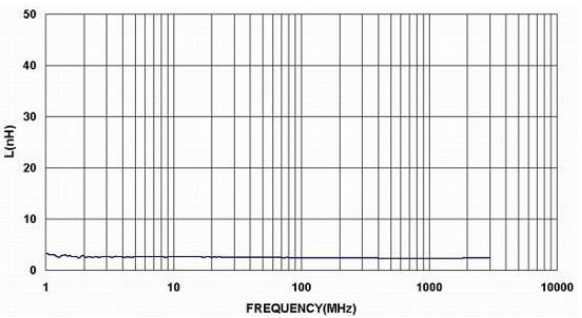
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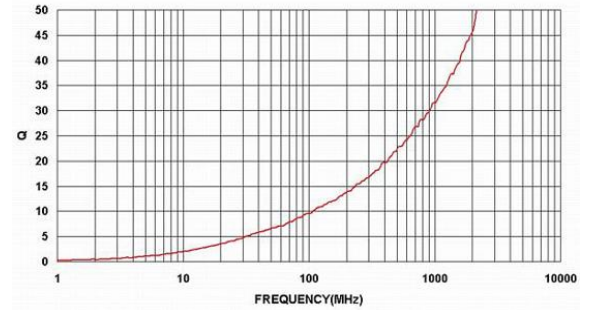
BSCH001005052N2SSM



BSCH001005052N4SSM

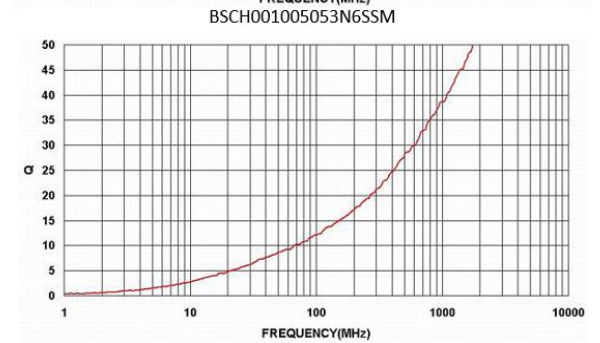
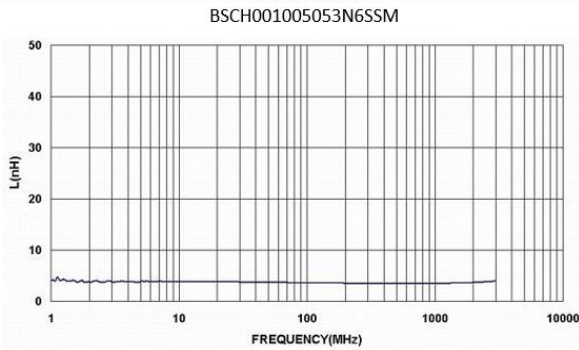
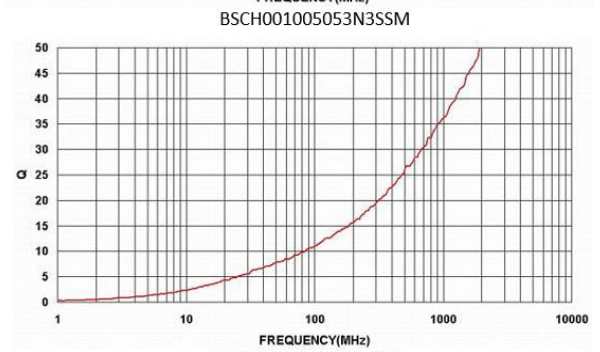
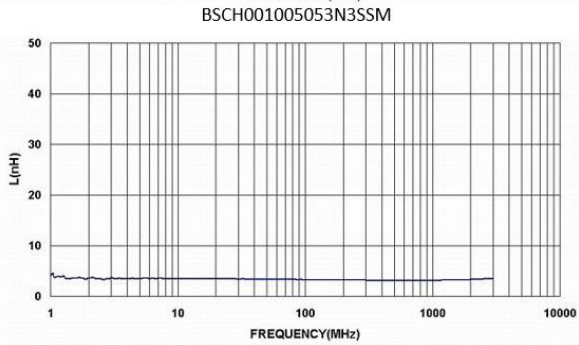
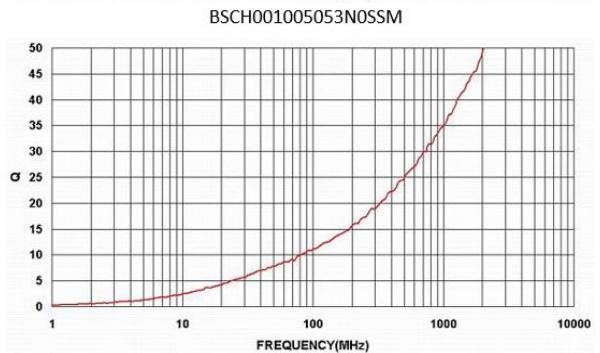
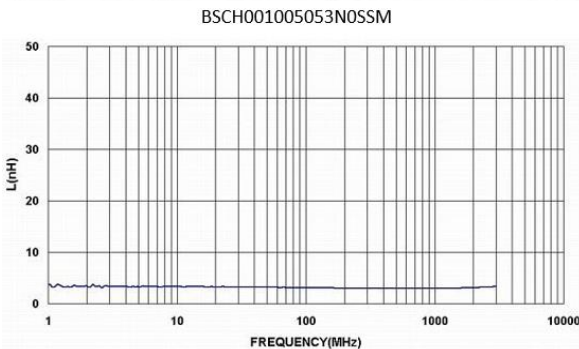
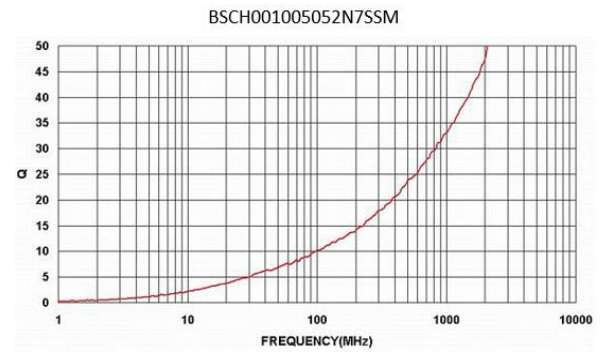
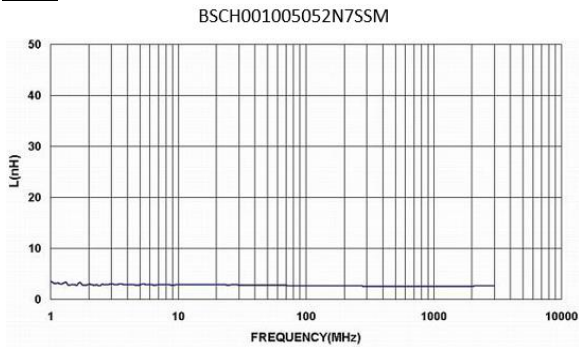


BSCH001005052N4SSM



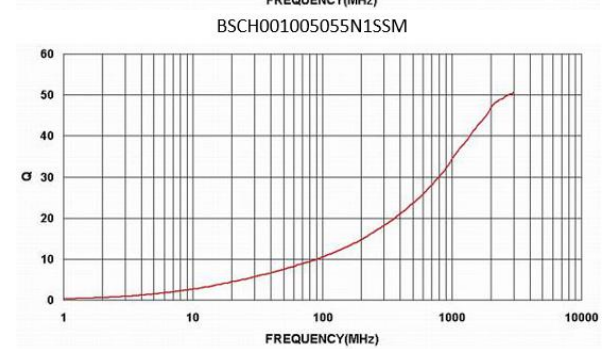
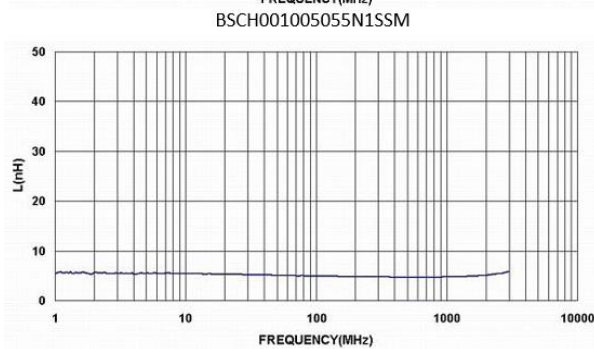
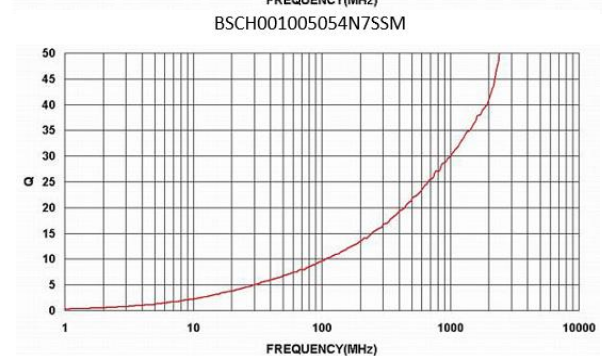
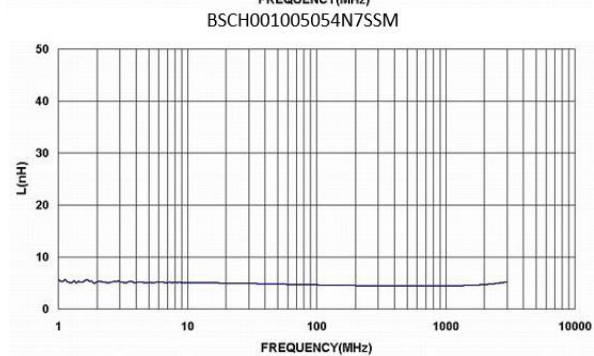
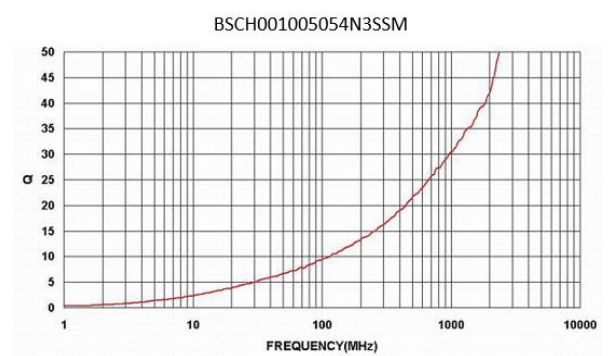
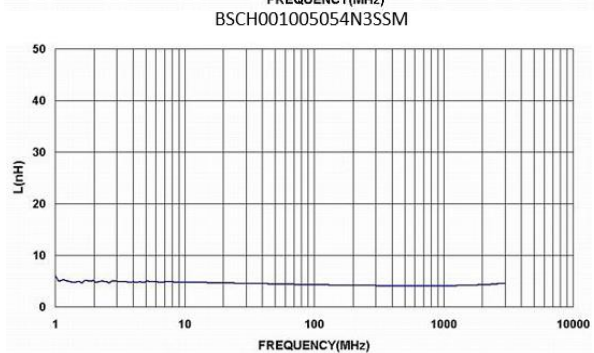
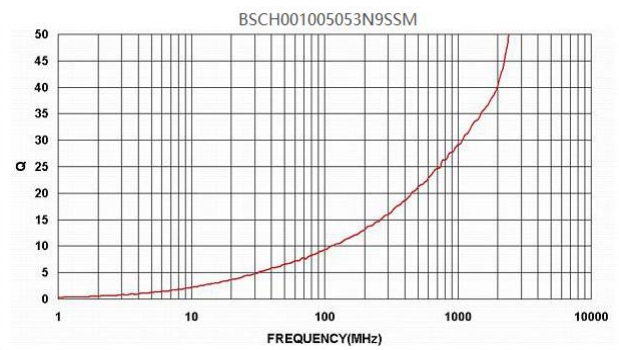
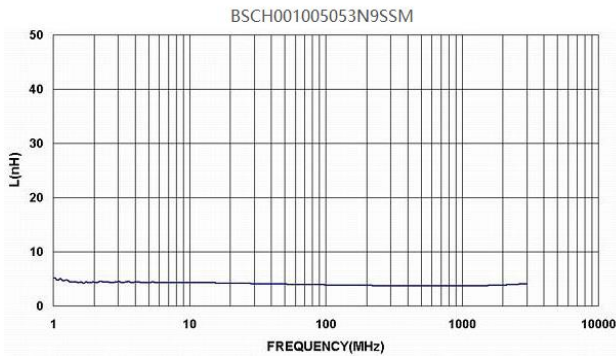
BSCH00100505 Series Specification

14 Graph:



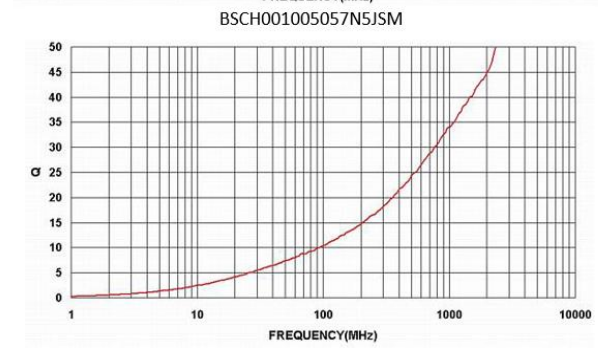
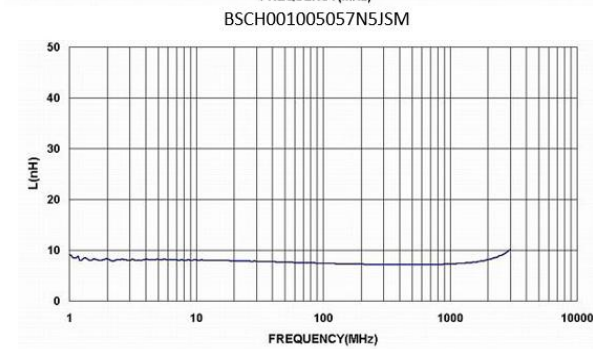
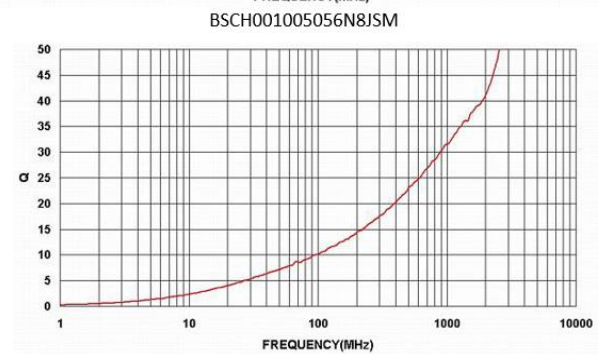
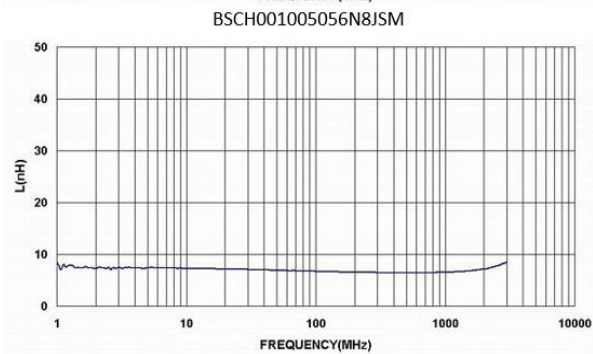
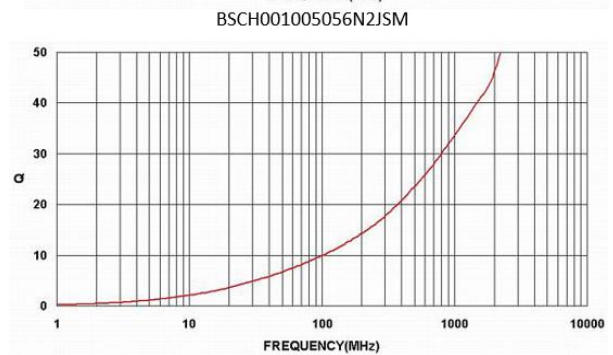
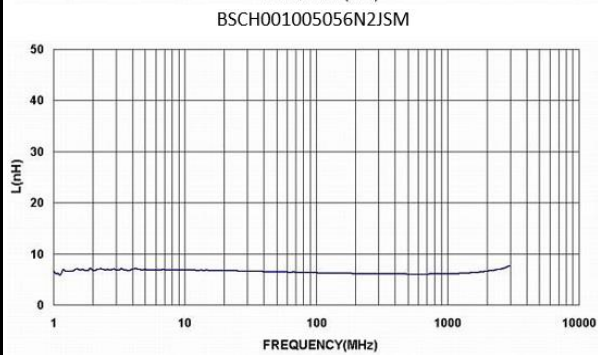
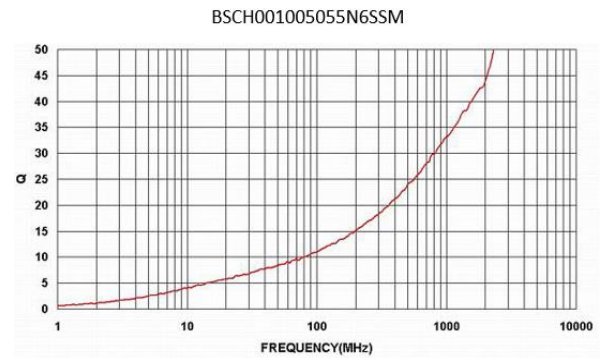
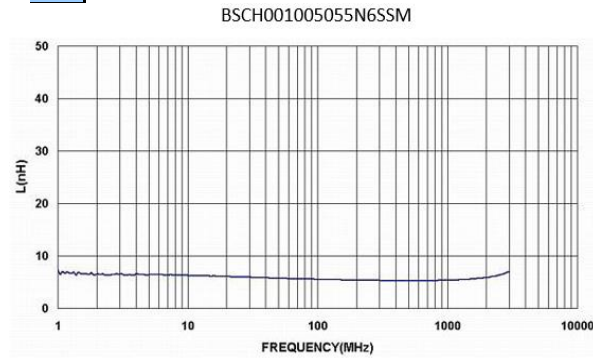
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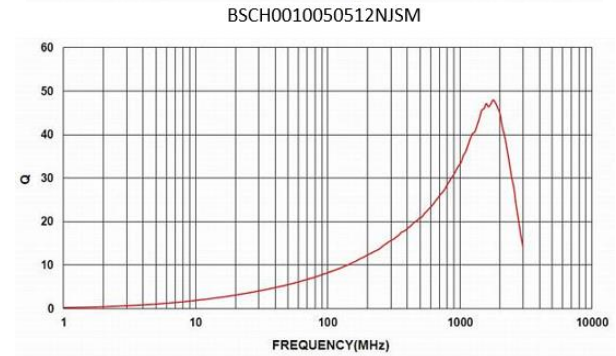
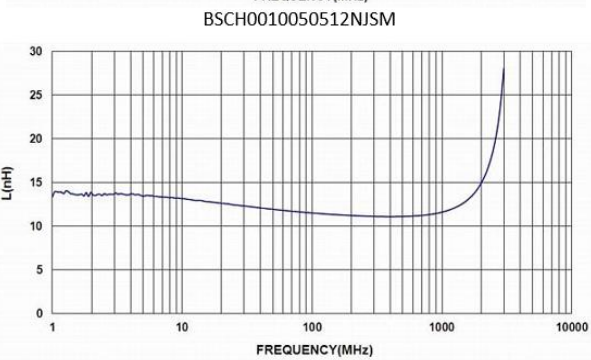
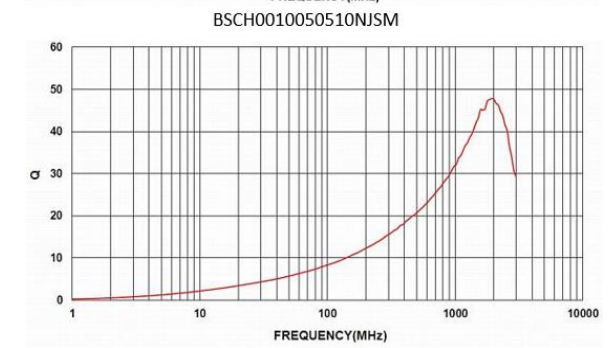
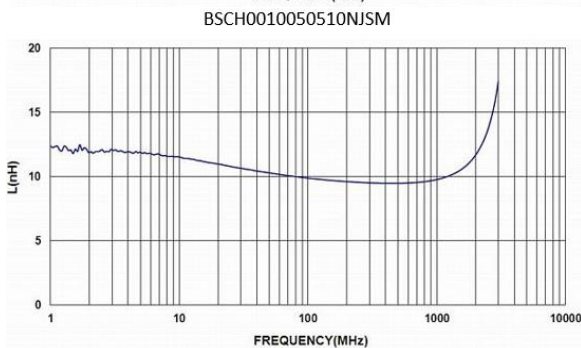
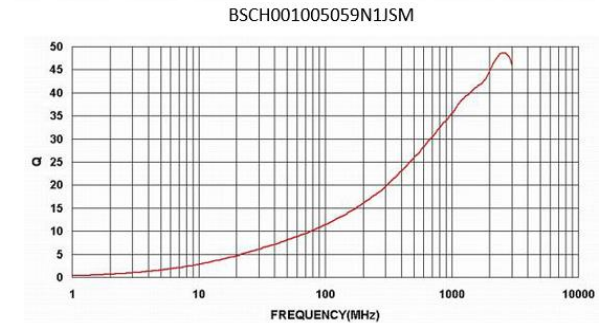
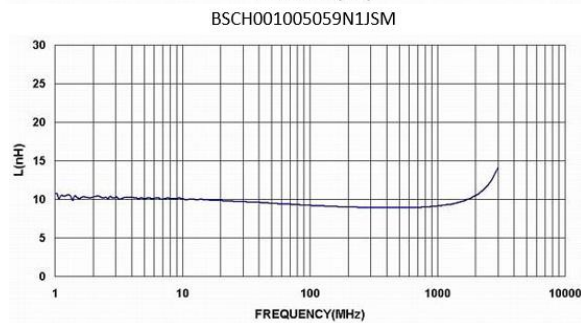
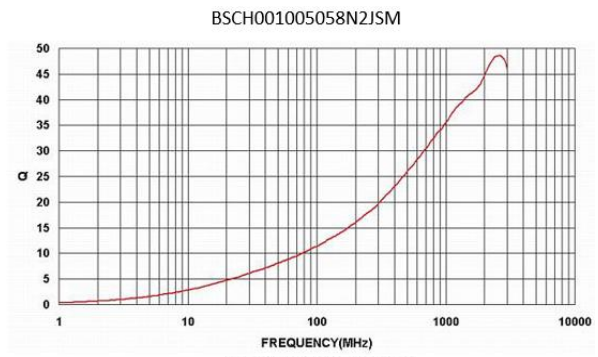
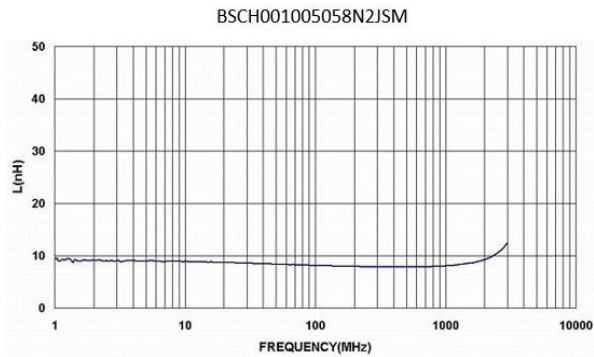
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